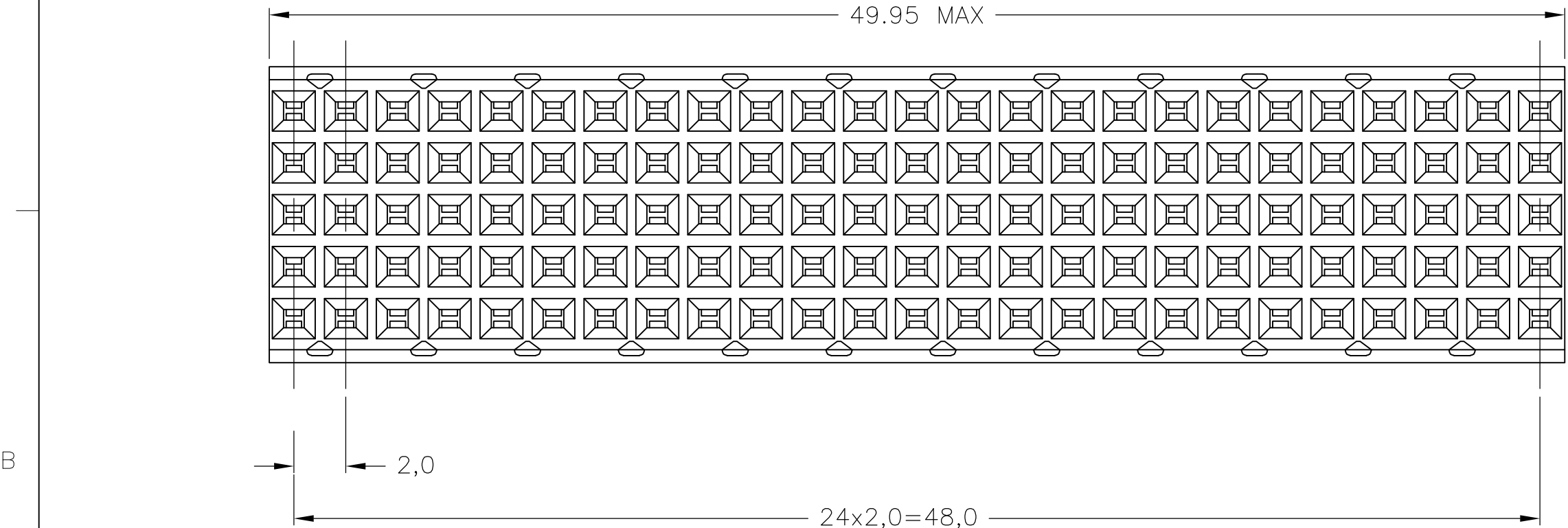
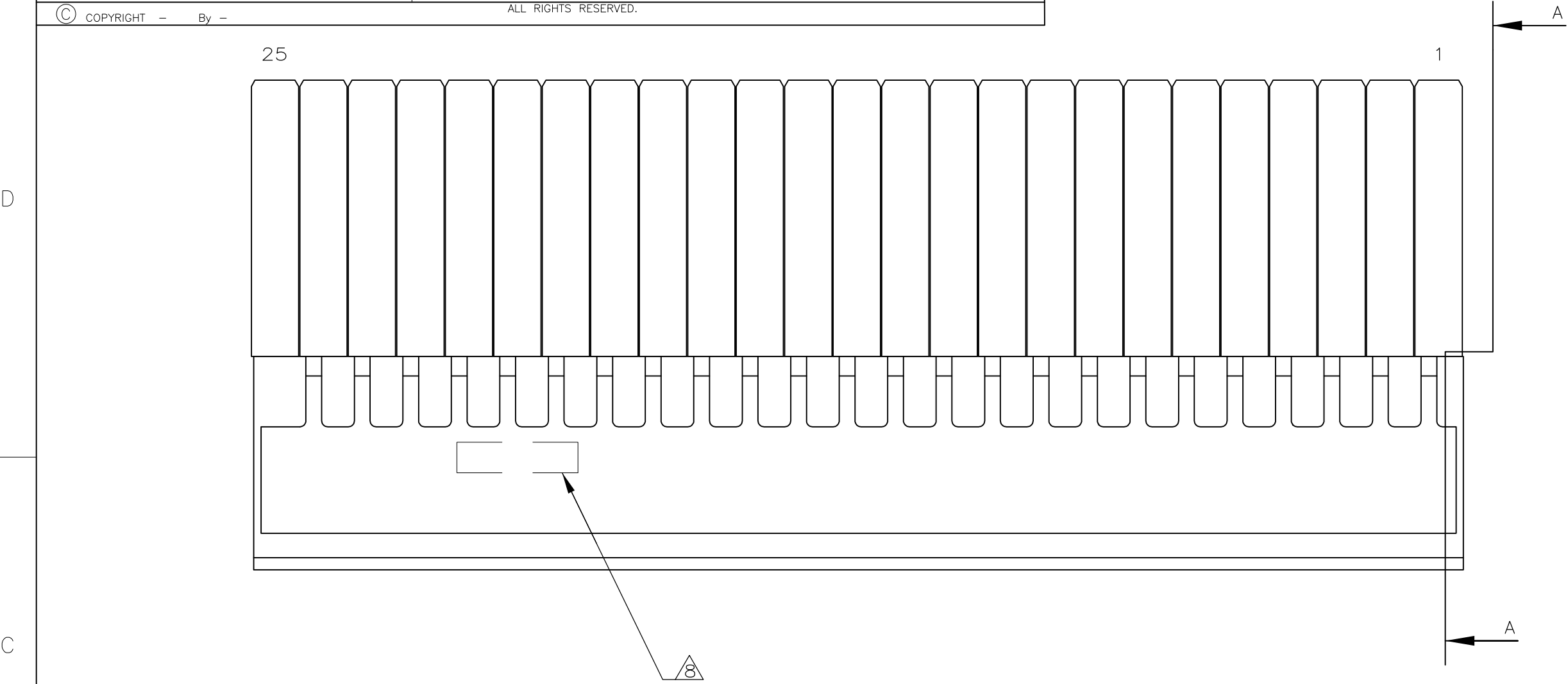
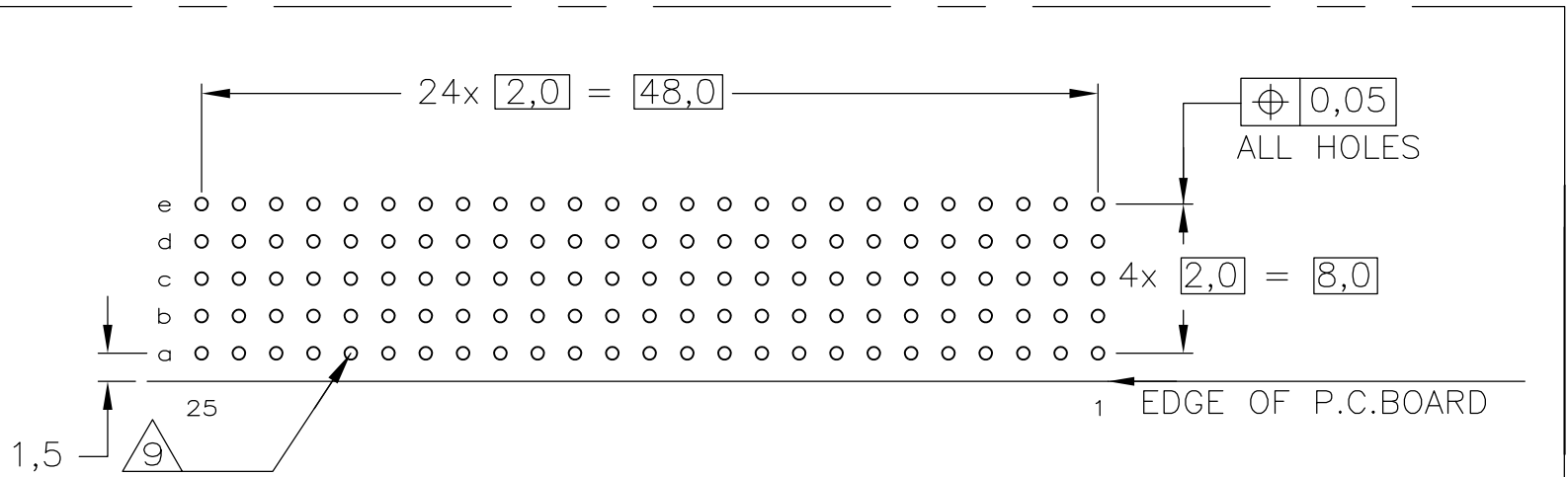




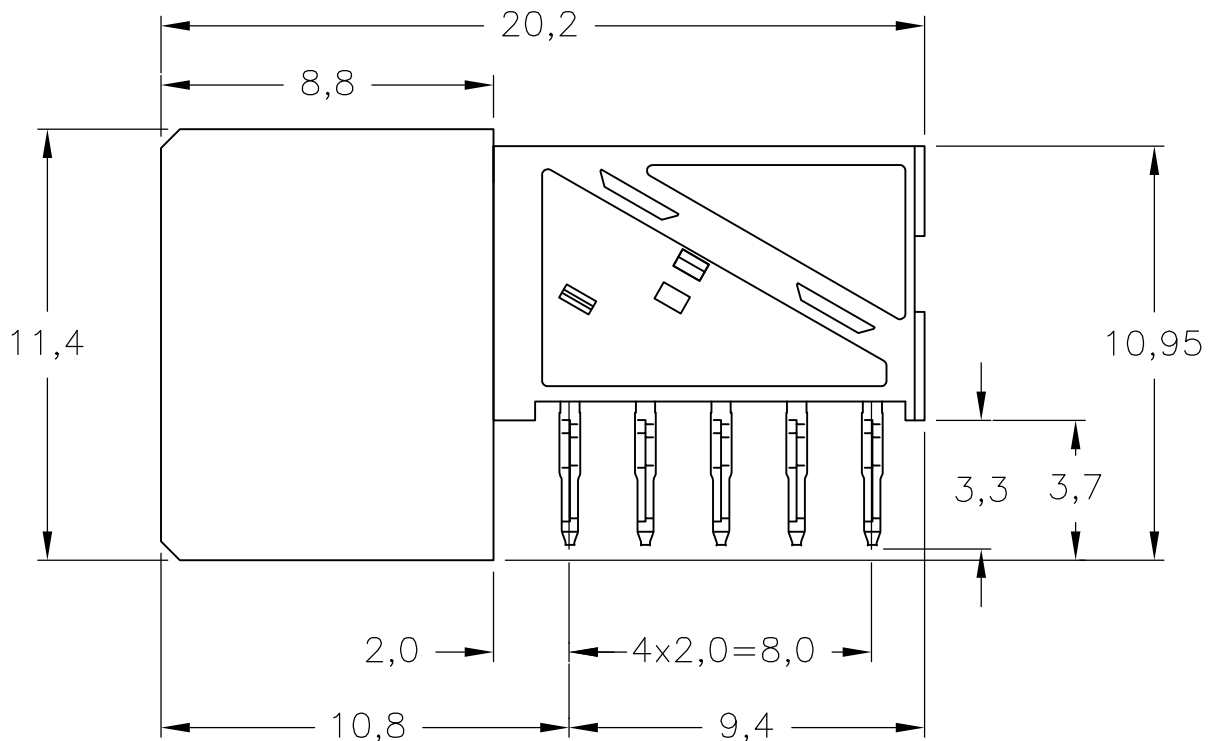
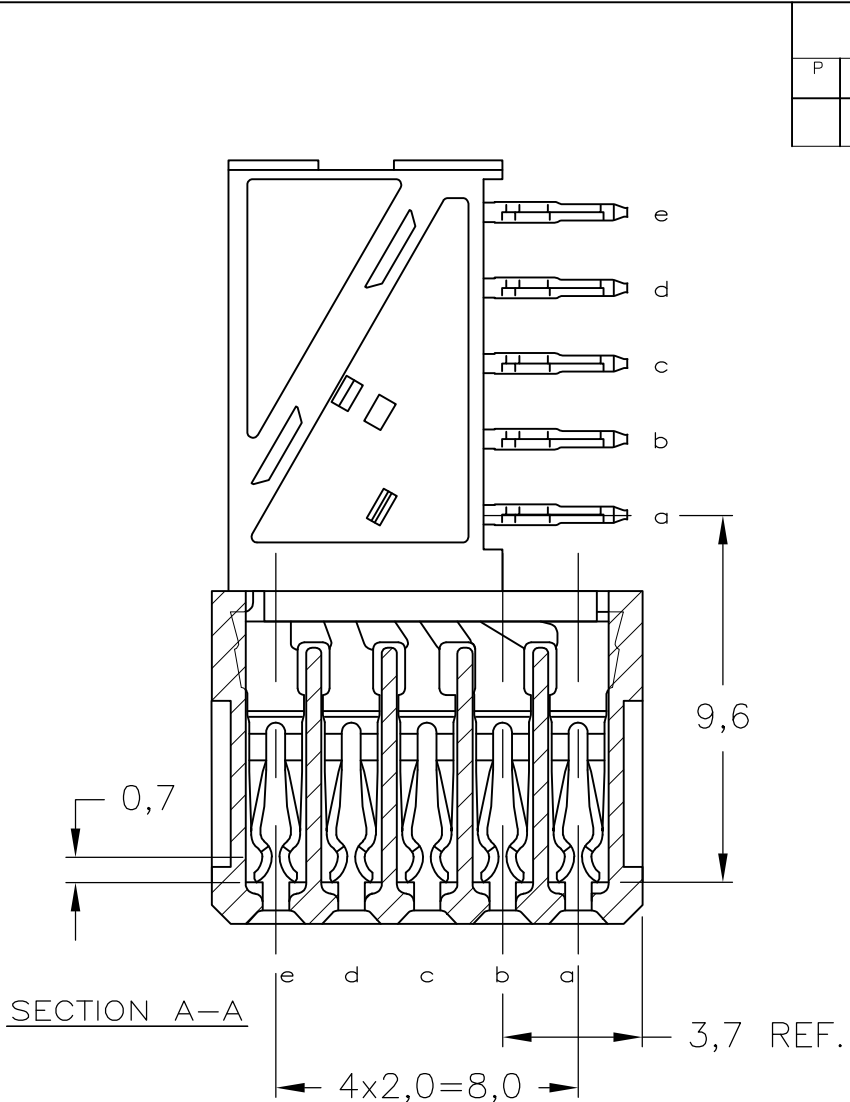
NOTES:

- MATERIAL CONTACT; PHOSPHORBRONZE
MATERIAL HOUSING; GLASSFILLED POLYESTER (GRAY)
UL-RATING 94V0.
- GENERAL PLATING SPECIFICATION: UNDERPLATING (ENTIRE CONTACT): 1,27µm NICKEL MIN.
AND ACTION PIN: 0,5µm TIN MIN.
FOR PLATING OF MATING SURFACES SEE APPLICABLE SPECIFICATION REFERENCE FOR EACH DASH NUMBER.
- CONFORMS TO ALL TESTING ACCORDING IEC 61076-4-101 PERFORMANCE LEVEL 2.
- CONFORMS TO ALL TESTING ACCORDING IEC 61076-4-101 PERFORMANCE LEVEL 1.
- CONNECTOR TESTED AND QUALIFIED AGAINST TELCORDIA GR-1217-CORE QUALITY LEVEL III, CENTRAL OFFICE APPLICATIONS.
- CONNECTOR TESTED AND QUALIFIED AGAINST TELCORDIA GR-1217-CORE QUALITY LEVEL III, UNCONTROLLED ENVIRONMENT APPLICATIONS.
- CONNECTOR LUBRICATED WITH TELCORDIA GR-1217-CORE APPROVED LUBRICANT.
- CONNECTOR PRINTED WITH PARTNUMBER AND DATECODE
THE MARKING CAN APPEAR ON THE FRONT SIDE OR ON THE BACK SIDE.
- PLATED-THROUGH HOLES AT 2x2mm SQUARE GRID. 125 HOLES
- FITS WITH INTEGRATED GROUND RETURN UPPERSHIELD, BASIC P.N. 5338109
AND INTEGRATED GROUND RETURN LOWERSHIELD, BASIC P.N. 5338110
- CONNECTOR ASSEMBLED WITH REDESIGNED CONTACTS.
- OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI
- 0.76µm MIN. GOLD PLATING AT MATING SURFACES.

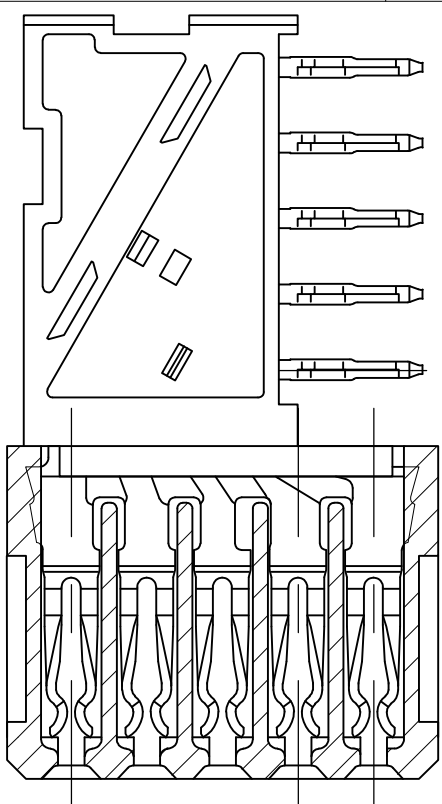


SCALE 2,5:1
COMPONENT SIDE AS SHOWN
RECOMMENDED PCB-HOLE LAY-OUT

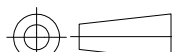
P.C.B. HOLE DIM. ACTION PIN
FOR DETAILS SEE
APPLICATION SPECIFICATION



REVISIONS					
P	LTR	DESCRIPTION	DATE	DWN	APVD
G		ECR-16-013297	21JUL2017	FL	SY



OBSOLETE			3-5100145-0	
			1-5100145-9	
			5100145-9	
OBSOLETE			5100145-4	
			5100145-1	
FINISH		MATERIAL		PARTNUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.			DWN K.N.KIRAN CHK B.MOOLJ APVD B.MOOLJ PRODUCT SPEC 108-19082 APPLICATION SPEC 114-19029 WEIGHT 0.0000		05AUG2004 22SEP2004 22SEP2004		 TE Connectivity		
DIMENSIONS: mm			TOLERANCES UNLESS OTHERWISE SPECIFIED:			NAME			
			0 PLG ±						